BB198

Variable capacitance diode for VCO and VCXO

Rev. 1 — 1 December 2010

Product data sheet

1. Product profile

1.1 General description

The BB198 is a low voltage variable capacitance diode for the Voltage Controlled Oscillator (VCO) and Voltage Controlled Crystal Oscillator (VCXO) applications.

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features and benefits

- Small plastic SMD package
- Very low operating voltage
- Large capacitance ratio $(C_{d(1V)}/C_{d(4V)} = 4.3 \text{ minimum})$
- Good capacitor-voltage (C-V) linearity
- Very low series resistance allowing high Q performance.

1.3 Applications

- Communication equipment
- Voltage Controlled Oscillators

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	JL
2	anode	1 2	sym008

^[1] The marking bar indicates the cathode.



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3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB198	SC-79	plastic surface-mounted package; 2 leads	SOD523

4. Marking

Table 3. Marking codes

Type number	Marking code
BB198	A3

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{R}	reverse voltage		-	20	V
l _F	forward current		-	100	mA
P _{tot}	total power dissipation	T _{sp} = 90 °C	-	300	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		–65	+150	°C

6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point		200	K/W

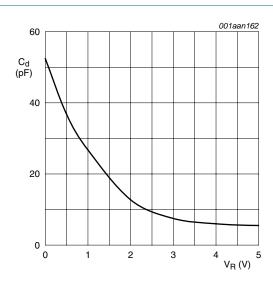
7. Characteristics

 Table 6.
 Characteristics

 $T_i = 25$ °C unless otherwise specified

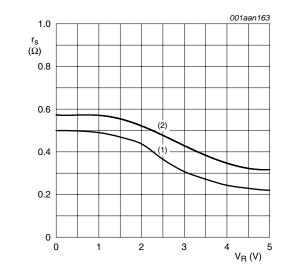
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I_R	reverse current	$V_R = 16 V$	-	-	5	nA
C_d	diode capacitance	f = 1 MHz				
		V _R = 1 V	25.0	-	28.5	pF
		V _R = 4 V	4.8	-	6.8	pF
rs	diode series resistance	$V_R = 1.5 \text{ V}; f = 100 \text{ MHz}$	-	0.48	8.0	Ω
C _{d(1V)} /C _{d(4V)}	diode capacitance ratio (1 V to 4 V)	f = 1 MHz	4.3	-	-	

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f = 1 MHz; $T_j = 25 \,^{\circ}\text{C}$.

Fig 1. Diode capacitance as function of reverse voltage; typical values

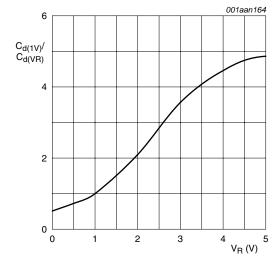


 $T_i = 25 \,^{\circ}C$.

(1) f = 100 MHz

(2) f = 470 MHz

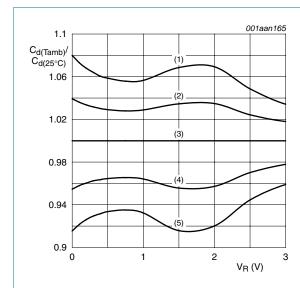
Fig 2. Diode reverse resistance as function of reverse voltage; typical values



f = 1 MHz; $T_i = 25 \,^{\circ}\text{C}$.

Fig 3. Diode capacitance ratio (1 V to V_R) as function of reverse voltage; typical values

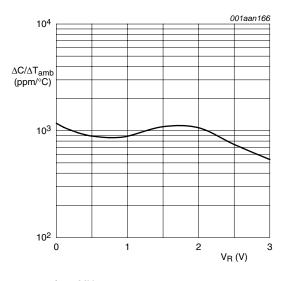
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f = 1 MHz.

- (1) $T_{amb} = 85 \, ^{\circ}C$
- (2) $T_{amb} = 55 \, ^{\circ}C$
- (3) $T_{amb} = 25 \, ^{\circ}C$
- (4) $T_{amb} = -15 \, ^{\circ}C$
- (5) $T_{amb} = -55 \, ^{\circ}C$

Fig 4. Diode capacitance ratio (T_{amb} to 25 °C) as function of reverse voltage; typical values



f = 1 MHz.

Fig 5. Capacitance temperature coefficient as function of reverse voltage; typical values

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8. Package outline

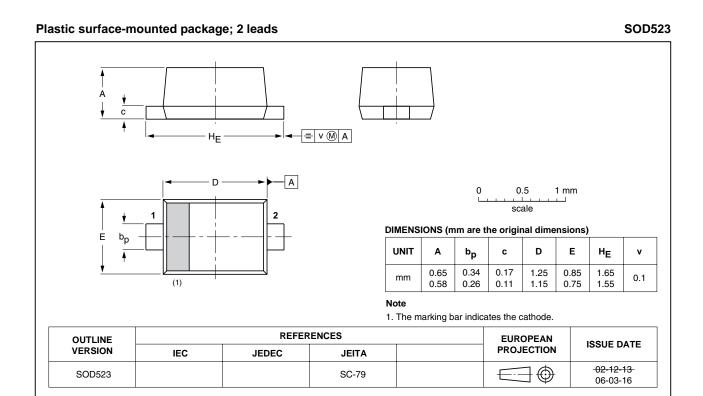


Fig 6. Package outline SOD523 (SC-79)

9. Abbreviations

Table 7. Abbreviations

Acronym	Description
Q	Quality factor
SMD	Surface Mounted Device

10. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB198 v.1	20101201	Product data sheet	-	-

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11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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